8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

Rev. 2 — 10 April 2013

Product data sheet

1. General description

The 74HC595-Q100; 74HCT595-Q100 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard No. 7A.

The 74HC595-Q100; 74HCT595-Q100 are 8-stage serial shift registers with a storage register and 3-state outputs. The registers have separate clocks. Data is shifted on the positive-going transitions of the shift register clock input (SHCP). The data in each register is transferred to the storage register on a positive-going transition of the storage register clock input (STCP). If both clocks are connected together, the shift register is always one clock pulse ahead of the storage register.

The shift register has a serial input (DS) and a serial standard output (Q7S) for cascading. It is also provided with asynchronous reset (active LOW) for all 8 shift register stages. The storage register has 8 parallel 3-state bus driver outputs. Data in the storage register appears at the output whenever the output enable input (OE) is LOW.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 8-bit serial input
- 8-bit serial or parallel output
- Storage register with 3-state outputs
- Shift register with direct clear
- 100 MHz (typical) shift out frequency
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

3. Applications

- Serial-to-parallel data conversion
- Remote control holding register



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74HC595-Q100; 74HCT595-Q100

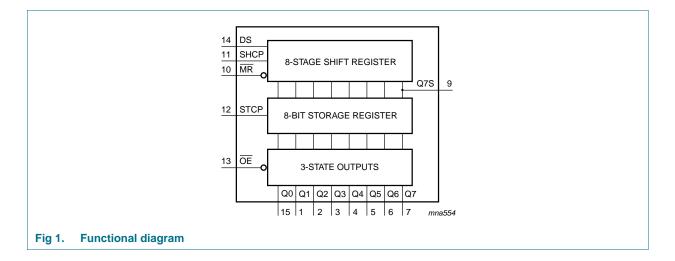
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4. Ordering information

. . .

Type number	Package					
	Temperature range	Name	Description	Version		
74HC595D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1		
74HCT595D-Q100			body width 3.9 mm			
74HC595DB-Q100	–40 °C to +125 °C	SSOP16				
74HCT595DB-Q100			body width 5.3 mm			
74HC595PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1		
74HCT595PW-Q100			body width 4.4 mm			
74HC595BQ-Q100	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced	SOT763-1		
74HCT595BQ-Q100			very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm			

5. Functional diagram

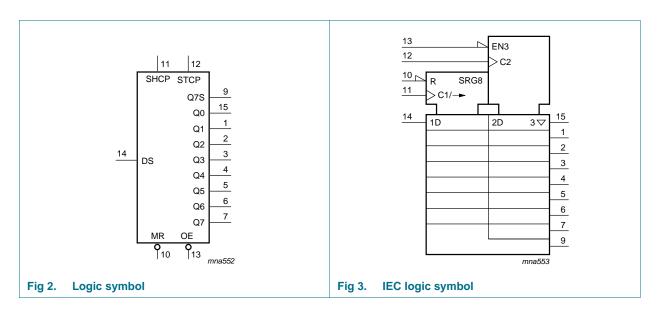


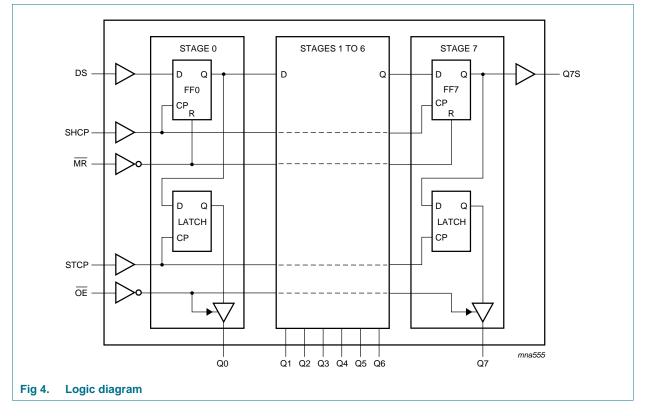
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6. Pinning information

6.1 Pinning

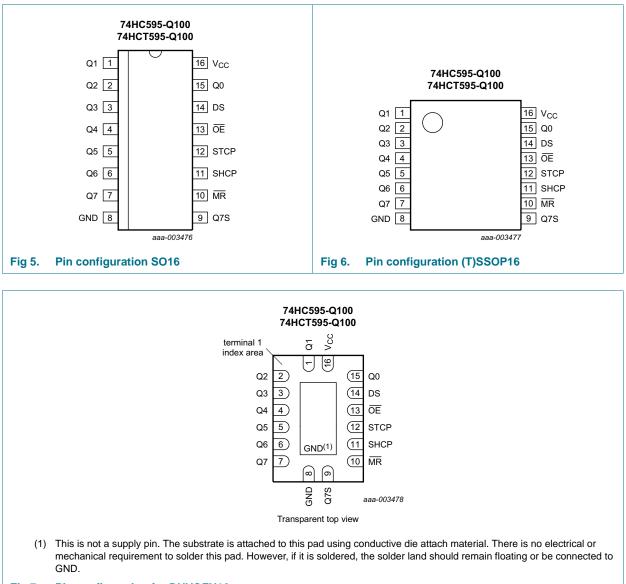


Fig 7. Pin configuration for DHVQFN16

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6.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
Q7S	9	serial data output
MR	10	master reset (active LOW)
SHCP	11	shift register clock input
STCP	12	storage register clock input
OE	13	output enable input (active LOW)
DS	14	serial data input
V _{CC}	16	supply voltage

7. Functional description

Table 3. Function table^[1]

Contro	bl			Input	Outpu	ıt	Function
SHCP	STCP	OE	MR	DS	Q7S	Qn	
Х	Х	L	L	Х	L	NC	a LOW-level on $\overline{\text{MR}}$ only affects the shift registers
Х	\uparrow	L	L	Х	L	L	empty shift register loaded into storage register
Х	Х	Н	L	Х	L	Z	shift register clear; parallel outputs in high-impedance OFF-state
↑	Х	L	Н	Η	Q6S	NC	logic HIGH-level shifted into shift register stage 0. Contents of all shift register stages shifted through, e.g. previous state of stage 6 (internal Q6S) appears on the serial output (Q7S).
Х	1	L	Н	Х	NC	QnS	contents of shift register stages (internal QnS) are transferred to the storage register and parallel output stages
\uparrow	↑	L	Н	Х	Q6S	QnS	contents of shift register shifted through; previous contents of the shift register is transferred to the storage register and the parallel output stages

[1] H = HIGH voltage state;

L = LOW voltage state;

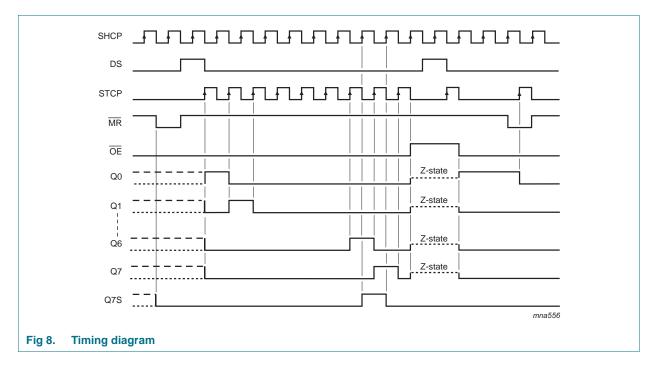
 \uparrow = LOW-to-HIGH transition;

X = don't care;

NC = no change;

Z = high-impedance OFF-state.

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8. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Max	Unit
supply voltage		-0.5	+7	V
input clamping current	V_{l} < -0.5 V or V_{l} > V_{CC} + 0.5 V	-	±20	mA
output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
output current	$V_{O} = -0.5 \text{ V}$ to ($V_{CC} + 0.5 \text{ V}$)			
	pin Q7S	-	±25	mA
	pins Qn	-	±35	mA
supply current		-	70	mA
ground current		-70	-	mA
storage temperature		-65	+150	°C
total power dissipation				
SO16 package		[1] _	500	mW
(T)SSOP16 package		[2] _	500	mW
DHVQFN16 package		[3]	500	mW
	supply voltage input clamping current output clamping current output current supply current ground current storage temperature total power dissipation SO16 package (T)SSOP16 package	$\begin{tabular}{ c c c } & supply voltage & & & & & & & & & & & & & & & & & & &$	supply voltage-0.5input clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{CC} + 0.5 V$ -output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{CC} + 0.5 V$ -output current $V_0 = -0.5 V \text{ to } (V_{CC} + 0.5 V)$ -pin Q7Spins Qnsupply current70storage temperature-65-65total power dissipation1-SO16 package11-(T)SSOP16 package2-	supply voltage -0.5 +7 input clamping current V ₁ < -0.5 V or V ₁ > V _{CC} + 0.5 V - ±20 output clamping current V ₀ < -0.5 V or V ₀ > V _{CC} + 0.5 V - ±20 output current V ₀ < -0.5 V to (V _{CC} + 0.5 V) - ±20 pin Q7S - ±25 ±25 pins Qn - ±35 supply current - 70 ground current -70 - storage temperature -65 +150 total power dissipation - 500 (T)SSOP16 package 11 - 500

[1] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

[2] For (T)SSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[3] For DHVQFN16 package: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

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9. Recommended operating conditions

Decomposited exerting conditions

Symbol	Parameter	Conditions	74H	IC595-C	100	74H	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
$\Delta t / \Delta V$	input transition rise and	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
	fall rate	$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	
74HC595	-Q100					1		
V _{IH}	HIGH-level	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	V
V _{IL}	LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	all outputs						
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	V
		I_O = -20 μ A; V_{CC} = 4.5 V	4.4	4.5	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	V
		Q7S output						
		$I_{O} = -4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	4.32	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.34	5.81	-	5.2	-	V
		Qn bus driver outputs						
		$I_{O} = -6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	4.32	-	3.7	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	5.81	-	5.2	-	V

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8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Мах	Min	Max	1
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$	1					
	output voltage	all outputs						
		$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	V
		I_{O} = 20 µA; V_{CC} = 4.5 V	-	0	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	V
		Q7S output						
		$I_{O} = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.33	-	0.4	V
		Qn bus driver outputs						
		$I_{O} = 6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.33	-	0.4	V
		I_{O} = 7.8 mA; V_{CC} = 6.0 V	-	0.16	0.33	-	0.4	V
lı	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 6.0 \text{ V};$ $V_O = V_{CC} \text{ or } \text{GND}$	-	-	±5.0	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	80	-	160	μA
CI	input capacitance		-	3.5	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Uni
			Min	Тур	Max	Min	Max	
74HCT59	5-Q100							
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$						
	output voltage	all outputs						
		I _O = -20 μA	4.4	4.5	-	4.4	-	V
		Q7S output						
		$I_{O} = -4 \text{ mA}$	3.84	4.32	-	3.7	-	V
		Qn bus driver outputs						
		$I_{O} = -6 \text{ mA}$	3.7	4.32	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$						
	output voltage	all outputs						
		I _O = 20 μA	-	0	0.1	-	0.1	V
		Q7S output						
		I _O = 4.0 mA	-	0.15	0.33	-	0.4	V
		Qn bus driver outputs						
		I _O = 6.0 mA	-	0.16	0.33	-	0.4	V
lı	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 5.5 \text{ V};$ $V_{O} = V_{CC} \text{ or } \text{GND}$	-	-	±5.0	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	80	-	160	μA
ΔI _{CC}	additional supply current	per input pin; $I_O = 0 A$; $V_I = V_{CC} - 2.1 V$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V						
		pins \overline{MR} , SHCP, STCP, \overline{OE}	-	150	675	-	735	μA
		pin DS	-	25	113	-	123	μA
CI	input capacitance		-	3.5	-	-	-	pF

Table 6. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 14.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
74HC59	5-Q100										
t _{pd}	propagation	SHCP to Q7S; see Figure 9	[2]								
	delay	$V_{CC} = 2 V$		-	52	160	-	200	-	240	ns
		$V_{CC} = 4.5 V$		-	19	32	-	40	-	48	ns
		$V_{CC} = 6 V$		-	15	27	-	34	-	41	ns
		STCP to Qn; see Figure 10	[2]								
		$V_{CC} = 2 V$		-	55	175	-	220	-	265	ns
		$V_{CC} = 4.5 V$		-	20	35	-	44	-	53	ns
		$V_{CC} = 6 V$		-	16	30	-	37	-	45	ns
		MR to Q7S; see Figure 12	[3]								
		$V_{CC} = 2 V$		-	47	175	-	220	-	265	ns
		$V_{CC} = 4.5 V$		-	17	35	-	44	-	53	ns
		$V_{CC} = 6 V$		-	14	30	-	37	-	45	ns
t _{en}	enable time	OE to Qn; see Figure 13	[4]								
		$V_{CC} = 2 V$		-	47	150	-	190	-	225	ns
		$V_{CC} = 4.5 V$		-	17	30	-	38	-	45	ns
		$V_{CC} = 6 V$		-	14	26	-	33	-	38	ns
t _{dis}	disable time	OE to Qn; see Figure 13	[5]								
		$V_{CC} = 2 V$		-	41	150	-	190	-	225	ns
		$V_{CC} = 4.5 V$		-	15	30	-	38	-	45	ns
		$V_{CC} = 6 V$		-	12	27	-	33	-	38	ns
t _W	pulse width	SHCP HIGH or LOW; see <u>Figure 9</u>									
		$V_{CC} = 2 V$		75	17	-	95	-	110	-	ns
		$V_{CC} = 4.5 V$		15	6	-	19	-	22	-	ns
		$V_{CC} = 6 V$		13	5	-	16	-	19	-	ns
		STCP HIGH or LOW; see Figure 10									
		$V_{CC} = 2 V$		75	11	-	95	-	110	-	ns
		$V_{CC} = 4.5 V$		15	4	-	19	-	22	-	ns
		$V_{CC} = 6 V$		13	3	-	16	-	19	-	ns
		MR LOW; see Figure 12									
		V _{CC} = 2 V		75	17	-	95	-	110	-	ns
		$V_{CC} = 4.5 V$		15	6	-	19	-	22	-	ns
		$V_{CC} = 6 V$		13	5	-	16	-	19	-	ns

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

Symbol	Parameter	Conditions			25 °C		–40 °C t	o +85 °C	–40 °C ∣	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	Min	Max	
t _{su}	set-up time	DS to SHCP; see Figure 10			1			I			
		$V_{CC} = 2 V$		50	11	-	65	-	75	-	ns
		$V_{CC} = 4.5 V$		10	4	-	13	-	15	-	ns
		$V_{CC} = 6 V$		9	3	-	11	-	13	-	ns
		SHCP to STCP; see Figure 11									
		$V_{CC} = 2 V$		75	22	-	95	-	110	-	ns
		V _{CC} = 4.5 V		15	8	-	19	-	22	-	ns
		$V_{CC} = 6 V$		13	7	-	16	-	19	-	ns
ĥ	hold time	DS to SHCP; see Figure 11									
		$V_{CC} = 2 V$		3	-6	-	3	-	3	-	ns
		$V_{CC} = 4.5 V$		3	-2	-	3	-	3	-	ns
		$V_{CC} = 6 V$		3	-2	-	3	-	3	-	ns
rec	recovery	MR to SHCP; see Figure 12									
	time	$V_{CC} = 2 V$		50	-19	-	65	-	75	-	ns
		V _{CC} = 4.5 V		10	-7	-	13	-	15	-	ns
		$V_{CC} = 6 V$		9	-6	-	11	-	13	-	ns
max	maximum frequency	SHCP or STCP; see <u>Figure 9</u> and <u>Figure 10</u>									
		$V_{CC} = 2 V$		9	30	-	4.8	-	4	-	MH
		$V_{CC} = 4.5 V$		30	91	-	24	-	20	-	MH
		$V_{CC} = 6 V$		35	108	-	28	-	24	-	MH
C _{PD}	power dissipation capacitance	f_i = 1 MHz; V_I = GND to V_{CC}	<u>[6][7]</u>	-	115	-	-	-	-	-	pF
74HCT59	95-Q100; V _{CC}	= 4.5 V to 5.5 V									
pd	propagation	SHCP to Q7S; see Figure 9	[2]	-	25	42	-	53	-	63	ns
	delay	STCP to Qn; see Figure 10	[2]	-	24	40	-	50	-	60	ns
		MR to Q7S; see Figure 12	[3]	-	23	40	-	50	-	60	ns
en	enable time	OE to Qn; see Figure 13	[4]	-	21	35	-	44	-	53	ns
dis	disable time	OE to Qn; see Figure 13	[5]	-	18	30	-	38	-	45	ns
Ŵ	pulse width	SHCP HIGH or LOW; see Figure 9		16	6	-	20	-	24	-	ns
		STCP HIGH or LOW; see <u>Figure 10</u>		16	5	-	20	-	24	-	ns
		MR LOW; see Figure 12		20	8	-	25	-	30	-	ns
su	set-up time	DS to SHCP; see Figure 10		16	5	-	20	-	24	-	ns
		SHCP to STCP; see Figure 11		16	8	-	20	-	24	-	ns
h	hold time	DS to SHCP; see Figure 11		3	-2	-	3	-	3	-	ns

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 14.

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Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C t	o +125 °C	Unit
			Min	Typ[1]	Мах	Min	Max	Min	Max	
t _{rec}	recovery time	MR to SHCP; see Figure 12	10	-7	-	13	-	15	-	ns
f _{max}	maximum frequency	SHCP and STCP; see <u>Figure 9</u> and <u>Figure 10</u>	30	52	-	24	-	20	-	MHz
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{\text{CC}}$ [6][7]	-	130	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 14.

[1] Typical values are measured at nominal supply voltage.

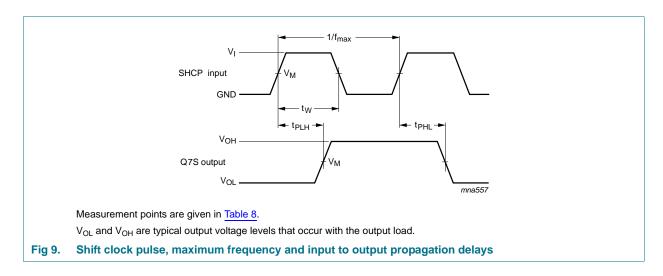
- [2] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [3] t_{pd} is the same as t_{PHL} only.
- [4] t_{en} is the same as t_{PZL} and t_{PZH}.
- [5] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [6] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

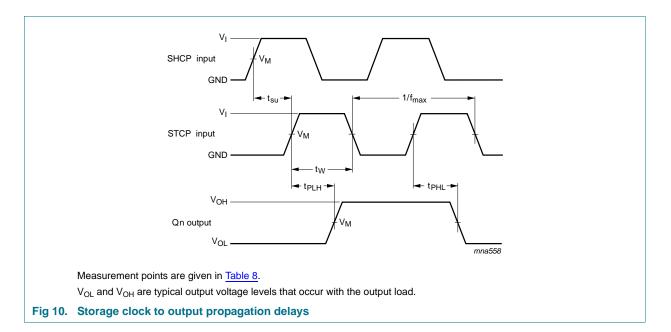
f_o = output frequency in MHz;

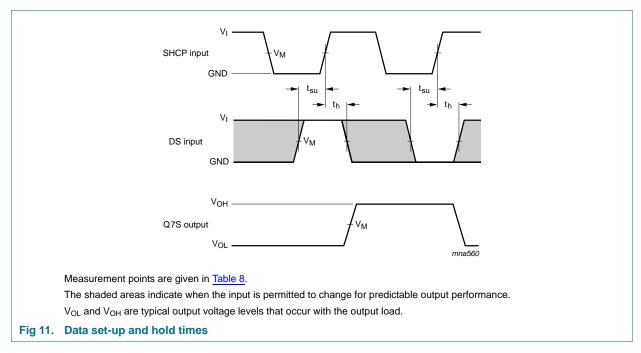
- $\Sigma(C_L \times V_{CC}^2 \times f_o) = sum of outputs;$
- C_L = output load capacitance in pF;
- V_{CC} = supply voltage in V.
- [7] All 9 outputs switching.

12. Waveforms



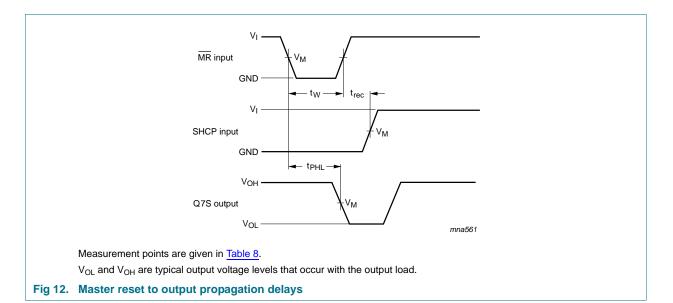
8-bit serial-in, serial or parallel-out shift register with output latches; 3-state





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8-bit serial-in, serial or parallel-out shift register with output latches; 3-state



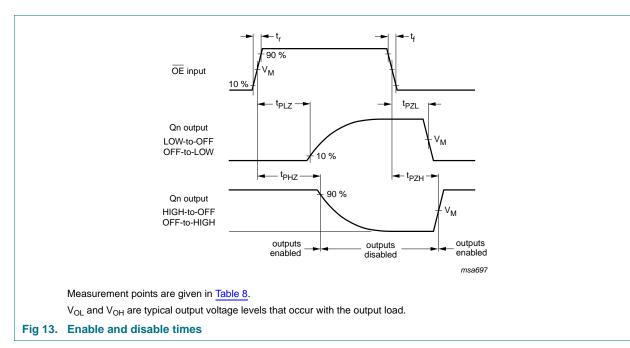


Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC595-Q100	0.5V _{CC}	0.5V _{CC}
74HCT595-Q100	1.3 V	1.3 V

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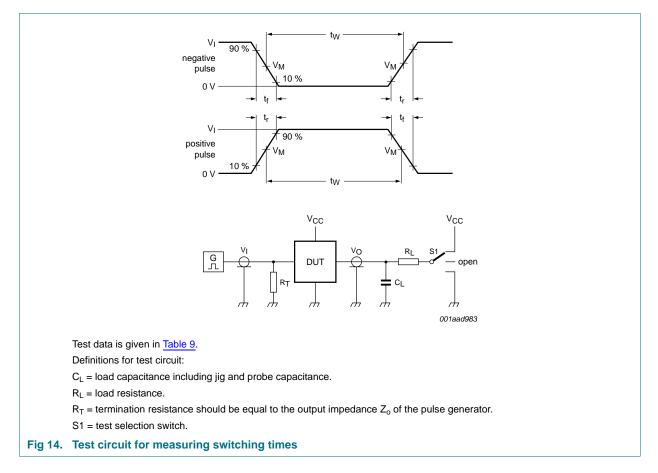


Table	9.	Test	data
IUNIC	.	1000	autu

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC595-Q100	V _{CC}	6 ns	50 pF	1 kΩ	open	GND	V _{CC}
74HCT595-Q100	3 V	6 ns	50 pF	1 kΩ	open	GND	V _{CC}

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

13. Package outline

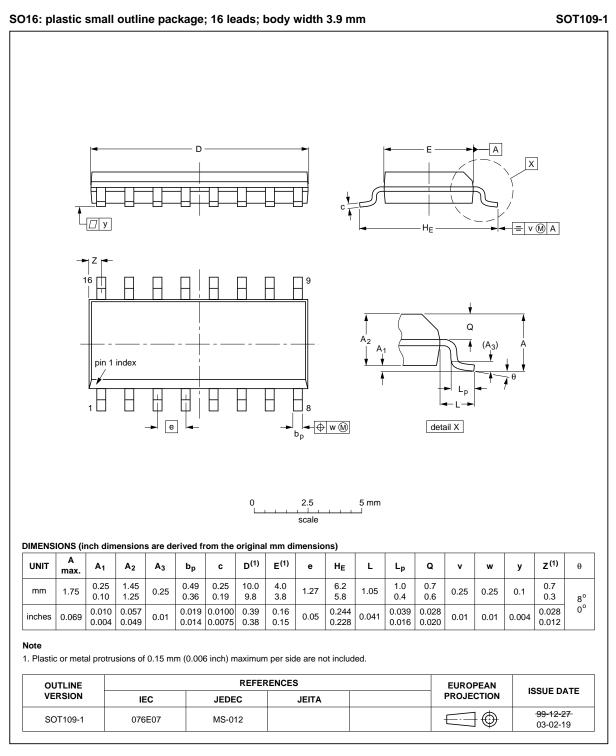


Fig 15. Package outline SOT109-1 (SO16)

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

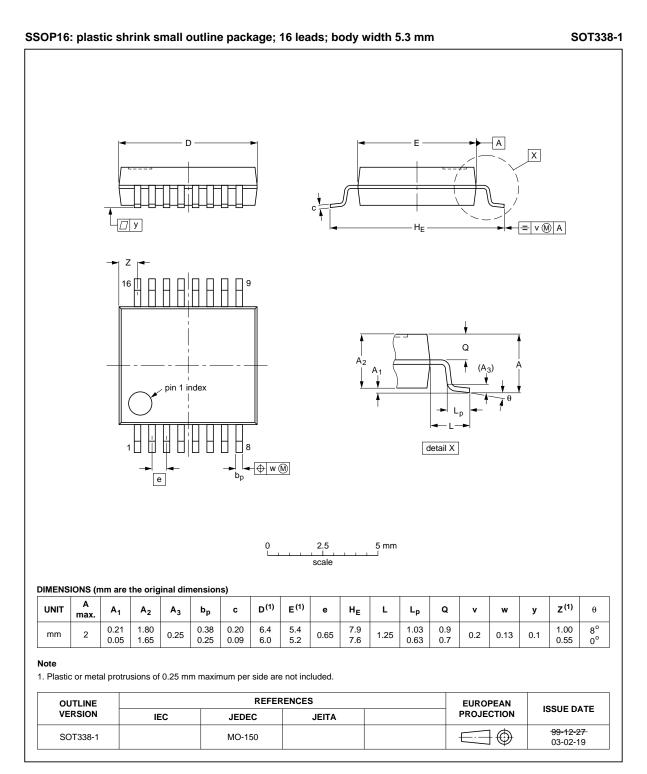


Fig 16. Package outline SOT338-1 (SSOP16)

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8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

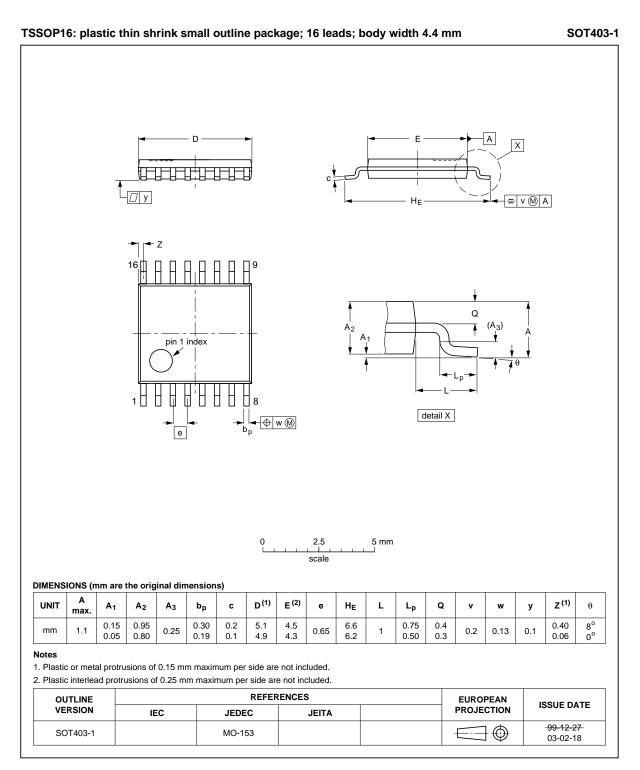
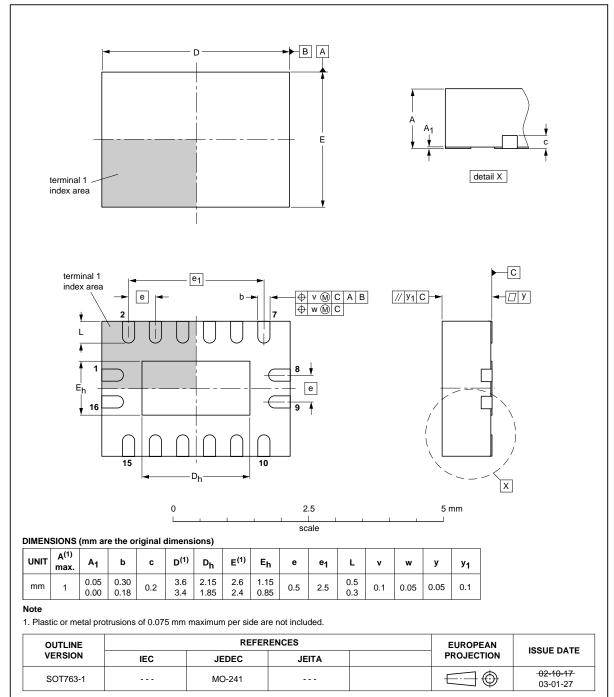


Fig 17. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 18. Package outline SOT763-1 (DHVQFN16)

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

14. Abbreviations

Table 10.	Abbreviations	
Acronym		Abbreviation
CMOS		Complementary Metal Oxide Semiconductor
DUT		Device Under Test
ESD		ElectroStatic Discharge
HBM		Human Body Model
LSTTL		Low-power Schottky Transistor-Transistor Logic
MM		Machine Model
MIL		Military

15. Revision history

Modifications: • 74HC595DB-Q100 and 74HCT595DB-Q100 added.	Table 11. Revision histo	ory			
Modifications: • 74HC595DB-Q100 and 74HCT595DB-Q100 added.	Document ID	Release date	Data sheet status	Change notice	Supersedes
	74HC_HCT595_Q100 v.2	20130410	Product data sheet	-	74HC_HCT595_Q100 v.1
	Modifications:	 74HC595DB 	-Q100 and 74HCT595DB-Q10	0 added.	
74HC_HCT595_Q100 v.1 20120802 Product data sheet	74HC_HCT595_Q100 v.1	20120802	Product data sheet	-	-

74HC_HCT595_Q100

8-bit serial-in, serial or parallel-out shift register with output latches; 3-state

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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74HC_HCT595_Q100

Product data sheet

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